

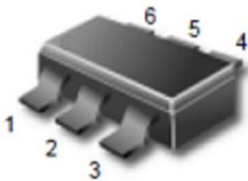
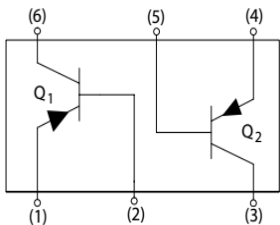
[illegible]



SOT-363 O P P 2 Q PNP R S T U V W X Double

Y Z [\] , ^ _ MMDT5551 ` a X C D b c X

d e f g] \ h i X



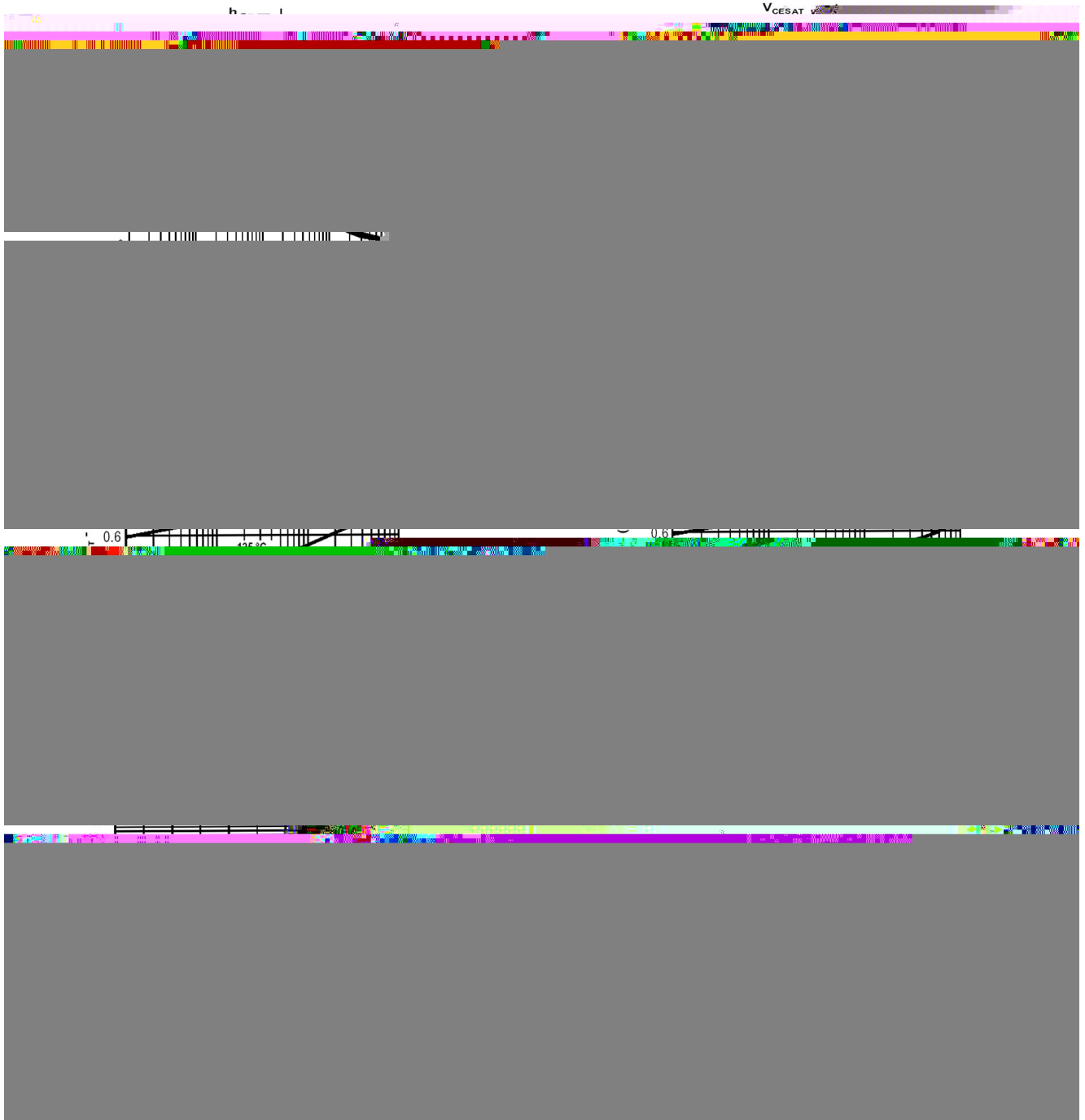
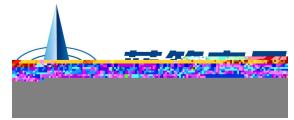
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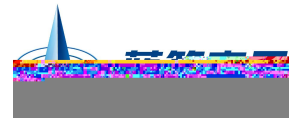
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F j

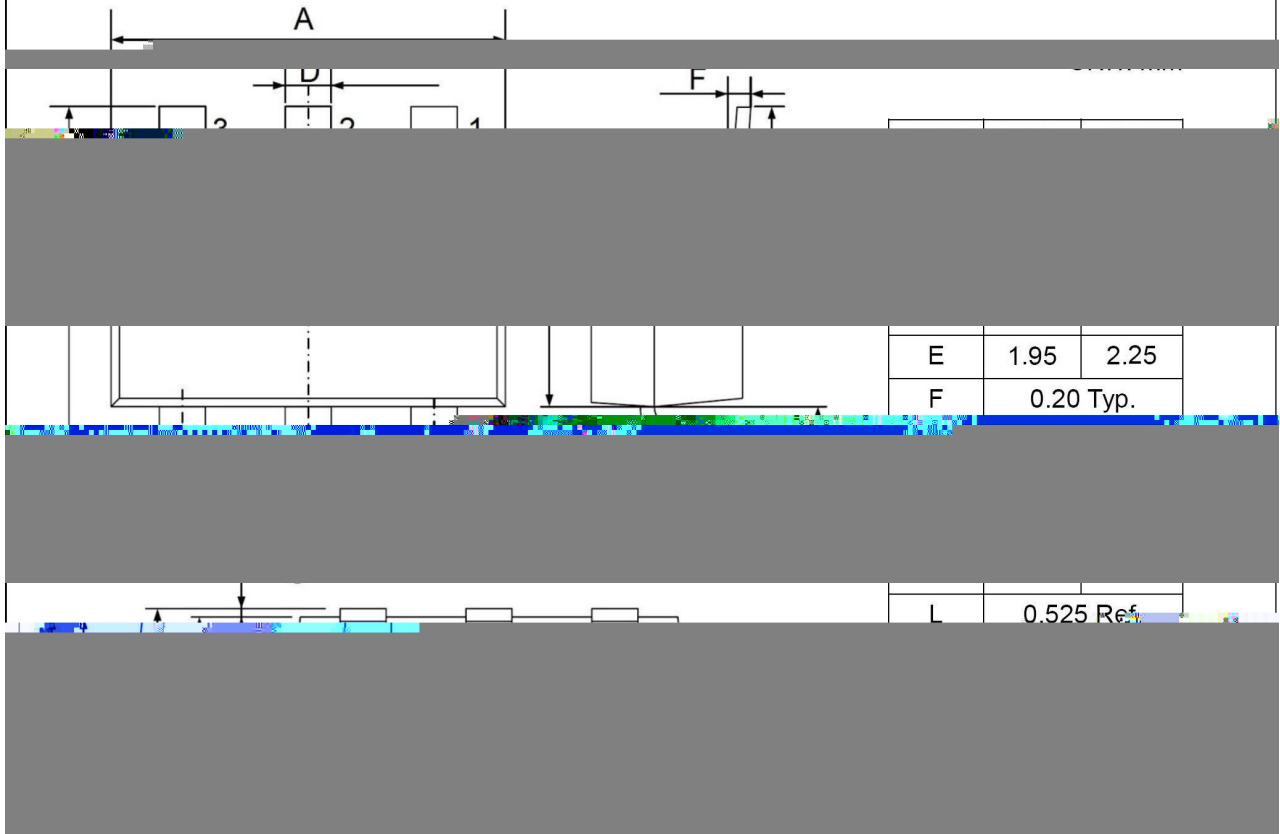


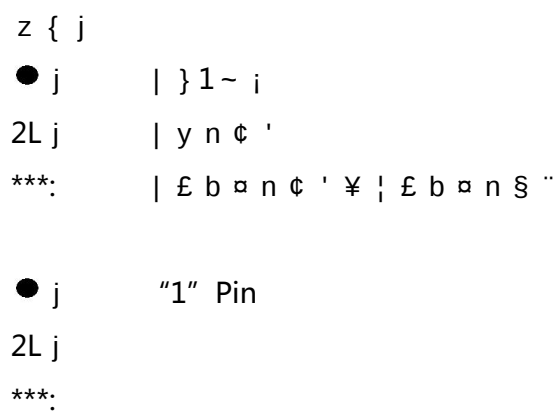
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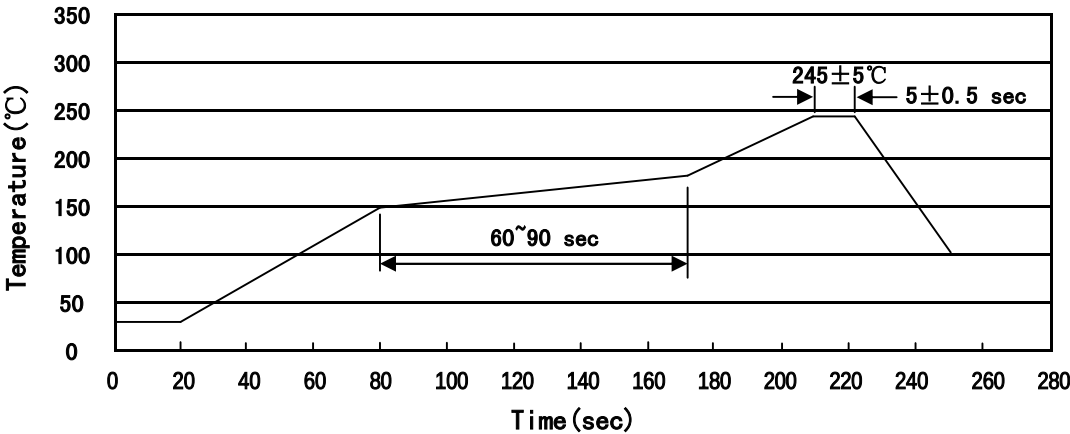
SOT-363-6L







Temperature Profile for IR Reflow Soldering(Pb-Free)



± °C

± °C

± °C

± °C

± °C

± °C

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-363	3,000	10	30,000	6	180,000	7" ×8	180×120×180	390×385×205